



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

SUNAGAWA, Takenobu et al.

Serial No.: 09/926,085

Filed: August 27, 2001

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JAN 29 2003

IC 1700

Group Art Unit: 1713

Examiner: Tatyana ZALUKAEVA

P.T.O. Confirmation No.: 2186

For: PROCESSING AID FOR THERMOPLASTIC RESIN AND  
THERMOPLASTIC RESIN COMPOSITION CONTAINING THE SAME

AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Date: January 27, 2003

Sir:

In response to the Office Action dated October 25, 2002, please amend the above-identified application as set forth below:

IN THE CLAIMS:

Amend the claims as follows:

1. (Amended): A processing aid for thermoplastic resin having a weight average molecular weight of 10,000 to 300,000, which is obtained by emulsion-polymerizing 0.1 to 10 % by weight of an alkyl (meth)acrylate having an oxygen atom in addition to an ester bond, 10 to 99.9 by weight of another alkyl acrylate, and 0.89.9 % by weight of another vinyl monomer copolymerizable therewith, in the presence of a mercaptan having an alkyl